

Свойства

850нм VCSEL лазер

до 300м на 50/125 мкм многомодовом оптическом кабеле

до 10.5Gbps

цифровая диагностика (DDMI)

дуплексный LC коннектор

Применение

10GBase-SR

STM-64

● Максимальные параметры

Parameter	Symbol	Min	Max	Unit
Storage Temperature	T_{ST}	-40	+85	°C
Operating Tempature	T_{OP}	-5	+70	°C
Supply Voltage 1	V_{CC3}	-0.5	+4.0	V
Supply Voltage 1	V_{CC5}	-0.5	+6.0	V

● Рекомендованные параметры

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage 1	V_{CC}	+3.1	3.3	+3.5	V
Supply Voltage 1	V_{CC}	+4.75	5.0	+5.25	V
Operating Temperature	T_{OP}	-5	-	+70	°C

● Электрические характеристики (Condition: $T_a=T_{OP}$)

❖ Parameter	Symbol	Min	Typ	Max	Unit	Note
Main Supply Voltage	Vcc5	4.75		5.25	V	
Supply Voltage #2	Vcc3	3.13		3.45	V	
Supply Current – Vcc5 supply	Icc5			250	mA	
Supply Current – Vcc3 supply	Icc3			500	mA	
Module total power	P			2.5	W	
Transmitter						
Input differential impedance	Rin		100		Ω	1
Differential data input swing	Vin,pp	120		1200	mV	
Transmit Disable Voltage	VD	2.0		Vcc	V	
Transmit Enable Voltage	VEN	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	340	650	850	mV	
Data output rise time	tr			38	ps	2
Data output fall time	tf			38	ps	2
LOS Fault	VLOS fault	Vcc – 0.5		VccHOST	V	3
LOS Normal	VLOS norm	GND		GND+0.5	V	3
Power Supply Rejection	PSR		See Note 4 below			4

1. After internal AC coupling.

2. 20 – 80 %

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3. Loss Of Signal is open collector to be pulled up with a 4.7k – 10kohm resistor to 3.15 – 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.

4. Per Section 2.7.1. in the XFP MSA Specification.

● Оптические параметры (Condition: $T_a=T_{op}$)

❖ Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Transmitter						
Operating Date Rate	B	9.9		10.5	Gb/s	
Bit Error Rate	BER			10^{-12}		
Optical Modulation Amplitude (OMA)	POMA	-4.3		-	dBm	1
Maximum Launch Power	PMAX	-7.0		-1.0	dBm	1
Optical Wavelength	λ	840		860	nm	
Optical Extinction Ratio	ER	3.5	5.5		dB	
Tx Jitter	Txj	Compliant with each standard requirements				
Optical Eye Mask		IEEE802.3ae				2
Receiver						
Operating Date Rate	B	9.9		10.5	Gb/s	
Receiver Sensitivity	R			-11.1	dBm	2
Stressed Sensitivity				-7.5	dBm	2
Maximum Input Power	PMAX	+0.5			dBm	2
Optical Center Wavelength	λ_C	840		860	nm	
Receiver Reflectance	Rrx			-12	dB	
LOS De-Assert	LOSD			-12	dBm	

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LOS Assert	LOSA	-25			dBm	
LOS Hysteresis		1			dB	

Notes:

1. The optical power is launched into MMF.
2. Measured with a PRBS $2^{31}-1$ test pattern @10.3125Gbps BER<10⁻¹².

● Цифровая диагностика (DDMI)

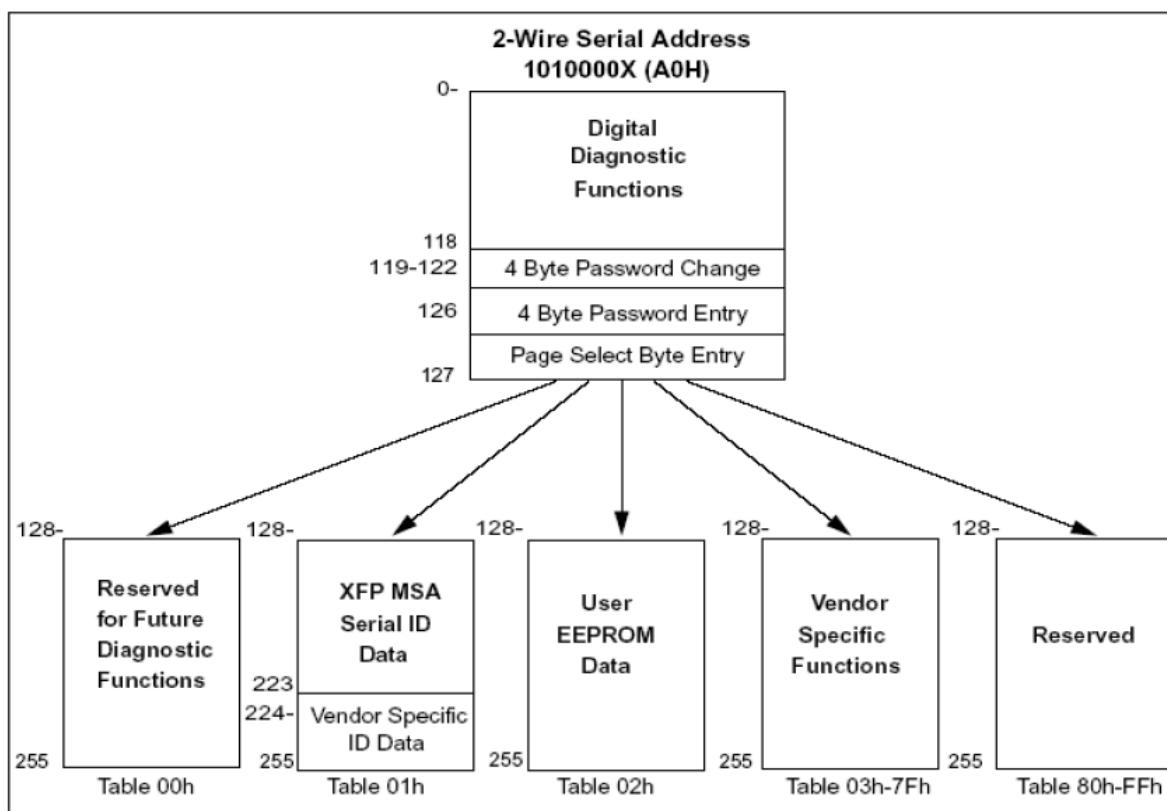
As defined by the XFP MSA 1 , OptTech XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- ✓ Transceiver temperature
- ✓ Laser bias current
- ✓ Transmitted optical power
- ✓ Received optical power
- ✓ Transceiver supply voltage

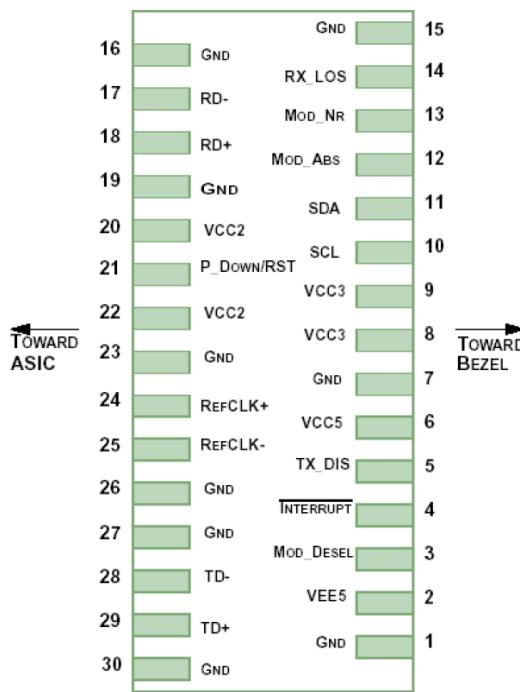
It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see the XFP MSA Specification.



Назначение контактов



◆ Diagram of Host Board Connector Block Pin Numbers and Name

● Описание контактов

✧	Logic	Symbol	Name/Description	Ref.
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTI-I	Mod-Desel	Module De-select; When held low allows the module to , respond to 2-wire serial interface commands	
4	LVTTI-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTI-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTI-I	SCL	Serial 2-wire interface clock	2
11	LVTTI-I/O	SDA	Serial 2-wire interface data line	2
12	LVTTI-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTI-O	Mod_NR	Module Not Ready;	2
14	LVTTI-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	

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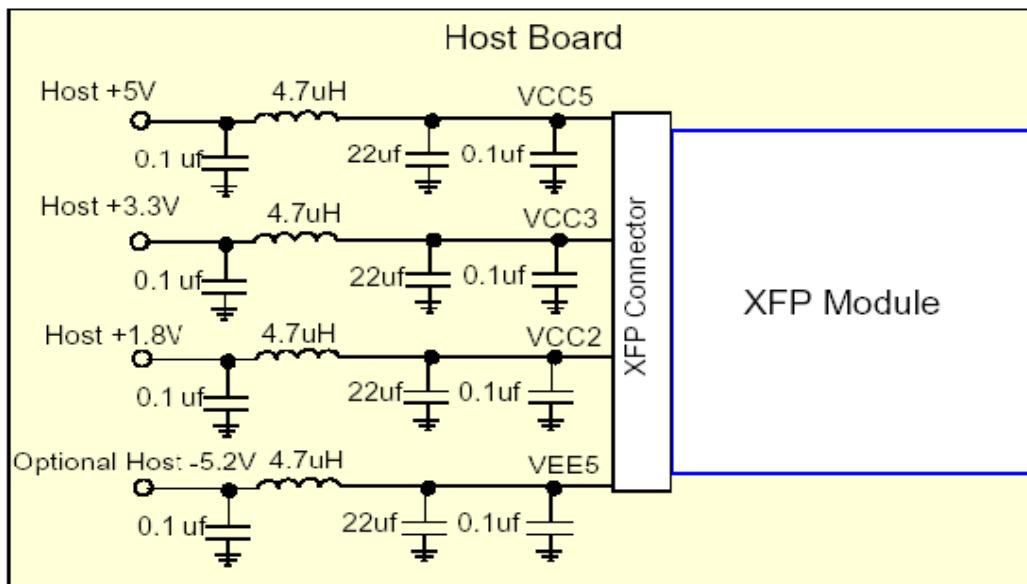
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – Not required	
21	LVTTI-I	P_Down/RST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
			Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply – Not required	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board – Not required	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

Note

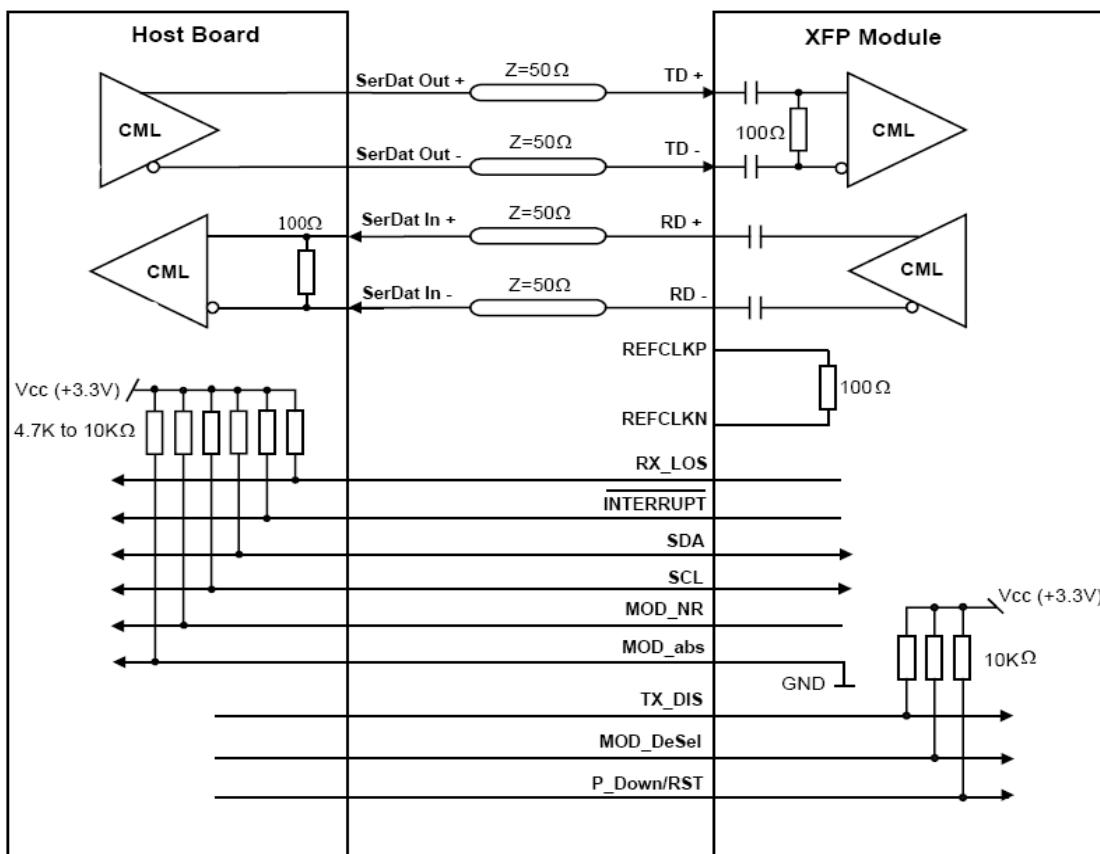
1. Module circuit ground is isolated from module chassis ground within the module.
2. Open collector; should be pulled up with 4.7k – 10k ohms on host board to a voltage between 3.15V and 3.6V.
3. A Reference Clock input is not required .

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● Рекомендованная схема включения



Recommended Host Board Power Supply Circuit



Recommended High-speed Interface Circuit

● Размеры

